

♦ STRUCTURE

Silicon Monolithic Integrated Circuit

♦ PRODUCT

CMOS 16kbit serial EEPROM built-in LDO REGULATOR

# **◇ PART NUMBER**

# BU9829GUL-W

PART NUMBER	PACKAGE
BU9829GUL-W	VCSP50L1

### ♦ FEATURES

### EEPROM PART

- 2,048 words ×8 bits architecture serial EEPROM
- Wide operating voltage range (1.6V~3.6V)
- Serial Peripheral Interface
- Self-timed write cycle with automatic erase
- Low Power consumption

Write (3.6V) : 1.5mA (Typ.)
Read (3.6V) : 0.5mA (Typ.)
Standby (3.6V) : 0.1 μ A (Typ.)

- Auto-increment of registers address for Read mode
- 32 byte Page Write mode
- DATA security

Defaults to power up with write-disabled state Software instructions for wirte-enable/disable Block writes protection by status register

Write inhibit at low Vcc
Data retention: 10 years

Endurance : 100,000 erase/write cycles
 Initial data FFh in all address and 00h in status register

### LDO REGULATOR PART

Low power consumption

Standby (3.6V) :  $0.1 \mu \text{ A (Typ.)}$ Operation (3.6V) : 0.1 mA (Typ.)

• Power on/off by enable pin

Setting output voltage by EEPROM coommand (VSET WRITE)

### ♦ ABSOLUTE MAXIMUM RATING (Ta=25°C)

Parameter	Symbol	Rating	Unit
Supply Voltage	Vcc1(EEPROM)	-0.3~4.5	V
Supply Voltage	Vcc2 (LDO)	0.5* 4.5	٧
Power Dissipation	Pd	220 (*)	mW
Storage Temperature	Tstg	−65 <b>~</b> 125	°C
Operating Temperature	Topr	−30 <b>~</b> 85	°C
Terminal Voltage	_	-0.3∼Vcc+0.3	V

<sup>\*</sup> Degradation is done at 2.2mW/°C(\*)

### ♦ EEPROM RECOMMENDED OPERATING CONDITION

Parameter	Symbol	Rating	Unit
Supply Voltage	Vcc1	1.6~3.6	V
Input Voltage	VIN	0~Vcc1	V

### ♦ LDO REGURATOR RECOMMENDED OPERATING CONDITION

Parameter	Symbol	Rating	Unit
Supply Voltage	Vcc2	2.9~3.6	V
Input Voltage	VIN	0~Vcc2	V



### ♦ MEMORY CELL CHARACTERISTICS(Ta=25°C, Vcc1=1.6~3.6V)

Parameter			116-24		
Parameter		Min.	Тур.	Max.	Unit
Write/Erase Cycle	*1	100,000	-	-	Cycle
Data Retention	*1	10	-	-	Year

### ♦ EEPROM DC OPERATING CHARACTERISTICS

### (Unless otherwise specified Ta=-30~85°C, Vcc1=1.6~3.6V)

_		Spe	cifica	ition				
Parameter	Symbol	Min.	Тур.	Max.	Unit	test condition		
"H" Input Voltage1	VIH1	0.7xVcc1	ı	Vcc1+0.3	٧	2.5V≦Vcc1≦3.6V		
"H" Input Voltage2	VIH2	0.75xVcc1	ı	Vcc1+0.3	٧	1.6V≦Vcc1<2.5V		
"L" Input Voltage1	VIL1	-0.3	ı	0.3xVcc1	>	2.5V≦Vcc1≦3.6V		
"L" Input Voltage2	VIL2	-0.3	ı	0.25xVcc1	>	1.6V≦Vcc1<2.5V		
"L" Output Voltage1	VOL1	0	ı	0.2	>	IOL=1.0mA, 2.5V≦Vcc1≦3.6V		
"L" Output Voltage2	VOL2	0	ı	0.2	>	IOL=1.0mA, 1.6V≦Vcc1<2.5V		
"H" Output Voltage1	VOH1	Vcc1-0.2	ı	Vcc1	>	IOH=-0.4mA, 2.5V≦Vcc1≦3.6V		
"H" Output Voltage2	VOH2	Vcc1-0.2	ı	Vcc1	>	IOH=−100 μ A, 1.6V≦Vcc1<2.5V		
Input Leakage Current	ILI	-1	ı	1	μА	VIN=0V~Vcc1		
Output Leakage Current	ILO	-1	ı	1	μА	VOUT=0V~Vcc1 , CSB=Vcc1		
	ICC1			1.5	mA	Vcc1=1.8V, fSCK=2MHz, tE/W=5ms		
Operating current	1001			1.5	IIIA	Byte Write, Page Write, Write Status Register		
Write	ICC2			2.0	mA	Vcc1=2.5V , fSCK=5MHz , tE/W=5ms		
	1002	_	-	2.0	mA	Byte Write, Page Write, Write Status Register		
	1000					Vcc1=1.8V , fSCK=2MHz, SO=OPEN		
Operating Current Read	ICC3 -	_	_	0.2	mA	Read, Read Status Register		
		-	-			Vcc1=2.5V , fSCK=5MHz, SO=OPEN		
	ICC4			0.6	mA	Read, Read Status Register		
Standby Current	ISB	-	ı	1.0	μΑ	Vcc1=3.6V, CSB=SCK=SI=Vcc1/GND,SO=OPEN		

# ♦ LDO REGULATOR DC OPERATING CHARACTERISTICS (Unless otherwise specified Ta=-30~85°C, Vcc2=2.9~3.6V)

Parameter	C. mak al	Spe	cifica	ition	Unit	Test condition
Parameter	Symbol	Min.	Тур.	Max.	Onit	rest condition
Output Voltage1-1	V <sub>OUT</sub> 1-1	2.9	3.0	3.2	٧	3.2V≦Vcc2≦3.6V, IOUT=0,2mA, VSET=1,0=[1:1]
Output Voltage1-2	V <sub>OUT</sub> 1-2	2.9	3.0	3.1	>	3.2V≦Vcc2≦3.6V, IOUT=2,10mA, VSET=1,0=[1:1]
Output Voltage2-1	V <sub>OUT</sub> 2-1	2.8	2.9	3.1	>	3.1V≦Vcc2≦3.6V, IOUT=0,2mA, VSET=1,0=[1:0]
Output Voltage2-2	V <sub>OUT</sub> 2-2	2.8	2.9	3.0	٧	3.1V≦Vcc2≦3.6V, IOUT=2,10mA, VSET=1,0=[1:0]
Output Voltage3-1	V <sub>OUT</sub> 3-1	2.7	2.8	3.0	٧	3.0V≦Vcc2≦3.6V, IOUT=0,2mA, VSET=1,0=[0:1]
Output Voltage3-2	V <sub>OUT</sub> 3-2	2.7	2.8	2.9	٧	$3.0V \le Vcc2 \le 3.6V$ , IOUT=2,10mA, VSET=1,0=[0:1]
Output Voltage4-1	V <sub>OUT</sub> 4-1	2.6	2.7	2.9	٧	2.9V≦Vcc2≦3.6V, IOUT=0,2mA, VSET=1,0=[0:0]
Output Voltage4-2	V <sub>OUT</sub> 4-2	2.6	2.7	2.8	٧	$2.9V \le Vcc2 \le 3.6V$ , IOUT=2,10mA, VSET=1,0=[0:0]
Operating Current	Icc	-	1	200	μА	Vcc2=3.6V, IOUT=0A
Standby Current	ISB	-	1	1.0	μА	Vcc2=3.6V, IOUT=0A, LDOEN=GND
"H"Input Voltage	VIH	1.4	1	Vcc2+0.3	>	2.9V≦Vcc2≦3.6V
"L"Input Voltage	VIL	-0.3Vcc2	1	0.6	>	2.9V≦Vcc2≦3.6V

OThis product is not designed for protection against radioactive rays.

### ♦ PIN No. / PIN NAME

DINIAL	DINI NIANAT
PIN No.	PIN NAME
A1	Vcc1
A2	CSB
A3	SCK
B1	Vcc2
B2	SI
B3	SO
C1	VOUT
C2	GND
C3	LDOEN

# ♦ EEPROM AC OPERATING CHARACTERISTICS

	(	Т	a=	-30	)∼	85	C
--	---	---	----	-----	----	----	---

Downston		1.6V≦Vcc1<1.8V			1.8V≦Vcc1≦3.6V			Unit	
Parameter		Symbol	Min.	Тур.	Max.	Min.	Тур.	Max.	Unit
SCK clock Frequency		fSCK	_	-	2.5	-	-	5	MHz
SCK High Time		tSCKWH	200	-	-	80	-	-	ns
SCK Low Time		tSCKWL	200	-	-	80	-	-	ns
CSB High Time		tCS	200	-	-	90	-	-	ns
CSB Setup Time		tCSS	150	-	-	60	-	-	ns
CSB Hold Time		tCSH	150	-	-	60	-	-	ns
SCK Setup Time		tSCKS	50	-	-	50	-	-	ns
SCK Hold Time		tSCKH	50	-	-	50	_	-	ns
SI Setup Time		tDIS	50	-	-	20	_	-	ns
SI Hold Time		tDIH	50	-	-	20	_	-	ns
Output Data Delay Time		tPD	ı	-	100	ı	_	80	ns
Output Hold Time		tOH	0	-	-	0	_	-	ns
Output Disable Time	*1	tOZ	-	-	200	ı	-	80	ns
SCK Rise Time	*1	tRC	ı	-	1	ı	_	1	μs
SCK Fall Time	*1	tFC	-	-	1	-	_	1	μs
Output Rise Time	*1	tRO	-	-	50	-	-	50	ns
Output Fall Time	*1	tF0	-	-	50	-	-	50	ns
Write Cycle Time		tE/W	-	-	5	-	-	5	ms
Wait Time From Vcc1 on EEPROM Command	То	tON	15	-	-	15	-	-	ms

\*1 Not 100% TESTED

# ♦ LDO REGULATOR AC OPERATING CHARACTERISTICS

### (Ta=-30~85°C)

Cumhal	2.9\	/≦Vcc≦	3.6V	11	Test condition
Symbol	Min.	Тур.	Max.	Offic	rest condition
tVcc1	-	-	5	msec	Vcc1x0%→Vcc1x95%point
tLDOEN	15	-	-	msec	Vcc1x0%point→LDOEN=High
		Symbol Min.	Nin.   Typ.	Min.         Typ.         Max.           tVcc1         -         -         5	Min.         Typ.         Max.         Unit           tVcc1         -         -         5         msec

# ♦BLOCK DIAGRAM

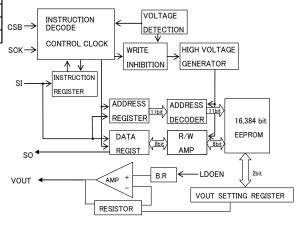


Fig.1 BLOCK DIAGRAM



### ♦ Input Power Supply Regulation Timing

### **1 Using EEPROM PART**

In case of using EEPROM part, be sure to raise Vcc1 up to operating voltage. In this time,

Vcc2 has no connection with operating.

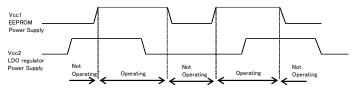


Fig.4 Using EEPROM Part, Regulation Timing

### **2**Using LDO REGULATOR PART

In case of using LDO regulator part, be sure to raise Vcc1 and Vcc2 up to operating voltage.

After rising Vcc1, wait 15msec and rising LDOEN. When LDOEN is raised, Vcc1 must be operating voltage.

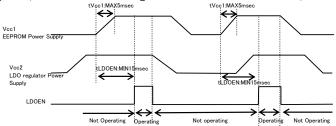


Fig.5 Using LDO REGULATOR Part, Regulation Timing

#### ♦ I/O APPLICATION CIRCUIT

Pull up resistor is indispensable condition.

When CSB is "H" during power ON/OFF, error operating and writing is protected.

### **OPULL UP RESISTOR OF CSB PIN**

The pull up resistor is needed in order to prevent error operating and writing from happening. Decide the value of this resistor (Rup) properly, considering VOH, IOH characteristics of controller.

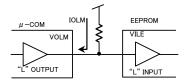


Fig.3 PULL UP RESISTOR OF CSB PIN

- VILE:VIL specification of EEPROM
- VOLM:VOL specification of CONTROLLER
- •IOLM:IOL specification of CONTROLLER

Example) When Vcc=5V, VILE=1.5V, VOLM=0.4V, IOLM=2mA, according to ①,

Rpu 
$$\geq \frac{5-0.4}{2 \times 10-3}$$
  
Rpu  $\geq 2.5[k\Omega]$ 

If the Rpu is under the conditions of the equation ①,

VOLM is 0.4V or more.

If the Rpu is under the conditions of the equation 2,

VILE(=1.5V) is VOLM or less.

#### **CAUTIONS ON USE**

### (1) Absolute maximum ratings

If the absolute maximum ratings such as impressed voltage and operating temperature range and so forth are exceeded, LSI may be destructed. Do not impress voltage and temperature exceeding the absolute maximum ratings. In the case of fear exceeding the absolute maximum ratings, take physical safety countermeasures such as fuses, and see to it that conditions exceeding the absolute maximum ratings should not be impressed to LSI.

(2) GND electric potential

Set the voltage of GND terminal lowest at any action condition. Make sure that each terminal voltages is lower than that of GND terminal.

(3) Heat design

In consideration of permissible dissipation in actual use condition, carry out heat design with sufficient margin.

(4) Terminal to terminal shortcircuit and wrong packaging

When to package LSI onto a board, pay sufficient attention to LSI direction and displacement. Wrong packaging may destruct LSI. And in the case of shortcircuit between LSI terminals and terminals and power source, terminal and GND owing to foreign matter, LSI may be destructed.

(5) Strong electromagnetic field

Use in a strong electromagnetic field may cause malfunction, therefore, evaluated design sufficiently.



# **♦PHYSICAL DIMENSION**

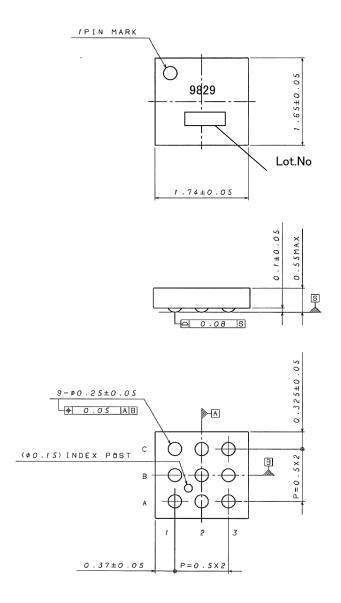


Fig.4 PHYSICAL DIMENSION VCSP50L1 (BU9829GUL-W)

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